



INTERNAL

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Local & Global Happenings

SSMC Sign MOU with Temasek Polytechnic Engineering School

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On 13 April 2015, SSMC Management Team and Leaders of Temasek Polytechnic (School of Engineering) had an official Memorandum of Understanding (MOU) Signing Ceremony held at Temasek Polytechnic. This helps to pave the way and foster closer collaborative activities in the areas of Structured Internship Placement Programs; Sponsorship of Course Medals and Subject Prizes; Recruitment and Career Development Initiatives; Industrial Visits and joint development of Continuing Education and Training (CET) Programs. Through the various initiatives we hope to create talents for making Singapore competitive and be ready for the 21st century semiconductor, electronic industry's landscape.



Temasek Polytechnic has an enrolment of 1600 students in the School of Engineering. The school has a strong industry fit and it adopts the philosophy of "Training WITH the Industry, and FOR the Industry" to tailored to market needs. SSMC works closely with Education Institutions including Temasek Poly to provide internship and career opportunities for the Students. We have hosted Industrial Visits for Temasek Poly Engineering Students to provide them an insight on the work environment and career opportunities upon graduation.



SSMC embraces many shared value with Temasek Polytechnic. SSMC is a holistic development framework in house and is also ITE certified OJT center. As part of vision of SSMC University, life learning, and raise value in our people by raising skills & developing competency level beyond job knowledge, cross-disciplines focus. Strong advocate of life-long learning journey.

This MOU signifies the partnership between Temasek and SSMC in reaching greater heights. Mr. Boo Kheng Hua, Principal & CEO of Temasek Polytechnic, used Henry Ford's famous quote to conclude the ceremony "Coming together is a beginning; keeping together is progress; working together is success." The MOU will sharpen the competitive edge of Education Institution and Industry. Together we raise value!

At the end of the visit, SSMC Team was invited to have a campus Tour at the Robotic and Automation Centre & Temasek Microelectronic Centre. The tour was very engaging and it was eye-opener experience to see the innovative robots development and sensors research works.

